Claims

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- 1. A curable composition comprising:
- (a) an epoxy resin and curing agent therefor, wherein said epoxy resin is essentially free of bromine atoms;
- (b) a flame retardant additive essentially free of phenolic groups and of epoxy groups, wherein said flame retardant is a condensation product of (i) a brominated phenol or a mixture of brominated phenols with (ii) a cyanuric halide;
- (c) a thermoplastic resin; and
- (d) a bismaleimide.

[c2]

[c1]

2. The curable composition of claim 1, wherein said flame retardant additive has a bromine content greater than 20%.

[c3]

3. The curable composition of claim 1, wherein said flame retardant additive is 1,3,5-tris(2,4,6-tribromophenoxy)triazine.

[c4]

4. The curable composition of claim 1, wherein said flame retardant additive is 2,2'-[(1-methylethylidene)bis[(2,6-dibromo-4,1-phenylene)oxy]]bis[4,6-bis [(2,4,6-tribromophenyl)oxy]-1,3,5-triazine].

[c5]

5. The curable composition of claim 1, wherein said flame retardant additive is soluble in toluene at a concentration of greater than 15 g/100ml of toluene at a temperature of 50 $^{\circ}$ C.

[c6]

6. The curable composition of claim 1, wherein said epoxy resin is a glycidyl ether resin or a mixture of glycidyl ether resins containing, on average, greater than 2 epoxy groups per molecule.

[c7]

- 7. The curable composition of claim 1, wherein said epoxy resin is a mixture of: (a1) an epoxy resin containing on average less than or equal to 2 glycidyl groups per molecule; and
- (a2) an epoxy resin containing greater than 2 glycidyl groups per molecule.

[c8]

8. The curable composition of claim 1, wherein said thermoplastic resin has a Tg greater than 120 $^{\circ}$ C.

[c9] 9. The curable composition of claim 1, wherein said thermoplastic resin has a dissipation factor of less than 0.010 measured at 1 MHz at room temperature. [c10]10. The curable composition of claim 1, wherein said thermoplastic resin has been directly isolated from solution after polymerization. [c11] 11. The curable composition of claim 1, wherein said thermoplastic resin is a poly(phenylene ether). [c12] 12. The curable composition of claim 11, wherein said poly(phenylene ether) has a weight average molecular weight ranging from about 3,000 to 35,000 g/mol. [c13] 13. The curable composition of claim 11, wherein said poly(phenylene ether) has a weight average molecular weight ranging from about 3,000 to 35,000 g/mol. [c14] 14. The curable composition of claim 11, wherein said poly(phenylene ether) has been melt processed at a temperature ranging from about 200 ° to 350 ° C. [c15]15. The curable composition of claim 11, wherein said poly(phenylene ether) is hydroxy functional. [c16]16. The curable composition of claim 1, wherein said thermoplastic resin is one or more of a poly(phenylene ether) or a poly(styrene- co-maleic anhydride). [c17] 17. The curable composition of claim 1, wherein said thermoplastic resin is a reaction product of a poly(phenylene ether) and a peroxide. [c18] 18. The curable composition of claim 1, wherein said thermoplastic resin is a reaction product of a poly(phenylene ether), a peroxide, and a bisphenol. [c19] 19. The curable composition of claim 1, wherein said thermoplastic resin is a polyimide. [c20]20. The curable composition of claim 1, wherein the curable composition further comprises one or more of an organic reinforcement, an inorganic

reinforcement, or a filler.

- [c21] 21. The curable composition of claim 1, wherein the curable composition is essentially free of homopolymers of styrene.
- [c22] 22. The curable composition of claim 1, wherein the epoxy resin is a multifunctional glycidyl ether.
- [c23] 23. The curable composition of claim 22, wherein said multifunctional glycidyl ether is selected from the group consisting of epoxidized phenol-formaldehyde novolacs, epoxidized cresol-formaldehyde novolacs, epoxidized alkylphenol-formaldehyde novolacs, epoxidized 1,1,1-tris(4-hydroxyphenyl)ethane, epoxidized 1,1,2,2-tetra(4-hydroxyphenyl) ethane, epoxidized phenol-dicyclopentadiene novolacs, and epoxidized phenol-benzaldehyde novolacs.
 - 24. The curable composition of claim 1, wherein said bismaleimide has the formula

$$R_1 = \begin{bmatrix} O \\ X_1 \\ X_2 \end{bmatrix}_k \qquad \text{(IV)}$$

wherein k is an integer of at least 2; X 1 and X 2 are identical or different and each represents a hydrogen atom, a halogen atom or a lower alkyl group; and R represents an aromatic or aliphatic organic group having a valence of k, which is selected from the group consisting of a linear or cyclic aliphatic hydrocarbon group having 4 to 16 carbon atoms, a monocyclic or fused ring aromatic hydrocarbon group, a triazine ring, a moiety resulting from the removal of the amino group from a condensation product of aniline and formaldehyde and a polybenzene group represented by the following formula:

wherein x represents 0 or 1 and when x represents 1, Y represents a linear, branched or cyclic aliphatic hydrocarbon group having 1 to 14 carbon atoms, a phenylene group, a xylylene group, an oxygen atom, a sulfur atom, a carbonyl group, a sulfonyl group, a sulfonyl group, an alkyleneoxyalkylene group, a

phosphonyl group, a phosphinyl group, or an imino group; and t is an integer of 1 or 2, or the homoprepolymer thereof obtained by reacting at least one of said polyfunctional maleimides under heat and stopping the reaction before the reaction mixture is gelled.

[c25]

- 25. A curable composition comprising:
- (a) an epoxy resin and curing agent therefor, wherein said epoxy resin is a glycidyl ether resin or mixture of glycidyl ether resins containing, on average, greater than 2 epoxy groups per molecule;
- (b) 1,3,5-tris(2,4,6-tribromophenoxy)triazine and/or 2,2'-[(1-methylethylidene) bis[(2,6-dibromo-4,1-phenylene)oxy]]bis[4,6-bis[(2,4,6-tribromophenyl)oxy]-1,3,5-triazine];
- (c) a poly(phenylene ether) resin; and
- (d) a bismaleimide.

[c26]

- 26. A curable composition comprising:
- (a) an epoxidized cresol-formaldehyde novolac resin;
- (b) 1,3,5-tris(2,4,6-tribromophenoxy)triazine; and
- (c) a poly(phenylene ether) resin having a number average molecular weight ranging from about 1,000 to 15,000 g/mol; and
- (d) a bismaleimide.

[c27]

- 27. A cured composition comprising a cured residue of a curable composition comprising:
- (a) an epoxy resin and curing agent therefor, wherein said epoxy resin is essentially free of bromine atoms;
- (b) a flame retardant additive essentially free of phenolic groups and of epoxy groups, wherein said flame retardant is a condensation product of (i) a brominated phenol or a mixture of brominated phenols with (ii) a cyanuric halide;
- (c) a thermoplastic resin; and
- (d) a bismaleimide.